## CLAIMS

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We claim:

1. A light emitting device comprising:

a first semiconductor layer of a first conductivity type having a first surface:

an active region overlying the first semiconductor layer, the active region including a second semiconductor layer, the second semiconductor layer one of a quantum well layer and a barrier layer, the second semiconductor layer formed from a III-Nitride semiconductor alloy having a composition graded in a direction substantially perpendicular to the first surface of the first semiconductor layer; and

a third semiconductor layer of a second conductivity type overlying the active region.

- The light emitting device of Claim 1, wherein the second semiconductor layer has a wurtzite crystal structure.
  - The light emitting device of Claim 1, wherein the composition of the III-Nitride semiconductor alloy is graded asymmetrically.
  - The light emitting device of Claim 1, wherein the composition of the III-Nitride semiconductor alloy is graded to reduce an effect of a piezoelectric field in the active region.
- The light emitting device of Claim 1, wherein a mole fraction of the III-Nitride semiconductor alloy is graded linearly.
  - 6. The light emitting device of Claim 1, wherein the III-Nitride semiconductor alloy is  $In_xAl_yGa_{1-x\cdot y}N$  with  $0\le x\le 1$ ,  $0\le y\le 1$ , and  $x+y\le 1$ .

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- The light emitting device of Claim 6, wherein the mole fraction of indium is graded.
- The light emitting device of Claim 6, wherein the mole fraction of
   aluminum is graded.
  - A method of forming a light emitting device, the method comprising:

forming a first semiconductor layer of a first conductivity type and having a first surface;

forming an active region over the first semiconductor layer, the active region including a second semiconductor layer, the second semiconductor layer one of a quantum well layer and a barrier layer, the second semiconductor layer formed from a III-Nitride semiconductor alloy having a composition graded in a direction substantially perpendicular to the first surface of the substrate; and

forming a third semiconductor layer of a second conductivity type over the active region.

- 20 10. The method of Claim 9, further comprising forming the second semiconductor layer in a wurtzite crystal structure.
  - The method of Claim 9, further comprising grading the composition of the III-Nitride semiconductor alloy asymmetrically.
  - 12. The method of Claim 9, further comprising grading the composition of the III-Nitride semiconductor alloy to reduce the effect of a piezoelectric field in the active region.
- 30 13. The method of Claim 9, further comprising grading a mole fraction of the III-Nitride semiconductor alloy linearly.

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- 14. The method of Claim 9, wherein the III-Nitride semiconductor alloy is  $In_xAl_yGa_{1:x:y}N$  with  $0 \le x \le 1$ ,  $0 \le y \le 1$ , and  $x + y \le 1$ .
- 5 15. The method of Claim 14, further comprising grading the mole fraction of inclum.
  - The method of Claim 14, further comprising grading the mole fraction of aluminum.
  - The method of Claim 1, wherein the active region is formed directly on the first semiconductor layer.
    - 18. A light emitting device comprising:
      a first semiconductor layer of a first conductivity type having a first surface;

an active region overlying the first semiconductor layer, the active region including a plurality of quantum well layers and at least one barrier layer, the barrier layer formed from a III-Nitride semiconductor alloy having an indium mole fraction graded in a direction substantially perpendicular to the first surface of the first semiconductor layer; and another semiconductor layer of a second conductivity type overlying the active region.

- 25 19. The light emitting device of Claim 18, wherein the barrier layer has a wurtzite crystal structure.
  - The light emitting device of Claim 18, wherein the indium mole fraction of the III-Nitride semiconductor alloy is graded asymmetrically.

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- 21. The light emitting device of Claim 18, wherein the indium mole fraction of the III-Nitride semiconductor alloy is graded to reduce an effect of a piezoelectric field in the active region.
- 5 22. The light emitting device of Claim 18, wherein the indium mole fraction of the III-Nitride semiconductor alloy is graded linearly.
  - 23. The light emitting device of Claim 18, wherein the III-Nitride semiconductor alloy is  $In_xAl_vGa_{1\times v}N$  with  $0\le x\le 1$ ,  $0\le y\le 1$ , and  $x+y\le 1$ .
  - 24. The light emitting device of Claim 18, wherein the active region includes a plurality of barrier layers each formed from a III-Nitride semiconductor alloy having an indium mole fraction graded in a direction substantially perpendicular to the first surface of the first semiconductor layer.
  - 25. A method of forming a light emitting device, the method comprising:

forming a first semiconductor layer of a first conductivity type having a first surface;

forming an active region overlying the first semiconductor layer, the active region including a plurality of quantum well layers and at least one barrier layer, the barrier layer formed from a III-Nitride semiconductor alloy having an indium mole fraction graded in a direction substantially perpendicular to the first surface of the first semiconductor layer; and

forming another semiconductor layer of a second conductivity type overlying the active region.

26. The method of Claim 25, further comprising forming the barrier layer in a wurtzite crystal structure.

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- The method of Claim 25, further comprising grading the indium mole fraction of the III-Nitride semiconductor alloy asymmetrically.
- 28. The method of Claim 25, further comprising grading the indium
  5 mole fraction of the III-Nitride semiconductor alloy to reduce an effect of a piezoelectric field in the active region.
  - The method of Claim 25, further comprising grading the indium mole fraction of the III-Nitride semiconductor alloy linearly.
  - $30. \qquad \text{The method of Claim 25, wherein the III-Nitride semiconductor} \\ alloy is $In_xAl_yGa_{1-x\cdot y}N$ with $0 \le x \le 1$, $0 \le y \le 1$, and $x+y \le 1$.}$
- 31. The method of Claim 25, wherein the active region includes a plurality of barrier layers each formed from a III-Nitride semiconductor alloy having an indium mole fraction graded in a direction substantially perpendicular to the first surface of the first semiconductor layer.